SWITCHMODE Power Rectifiers

Features

- Low Power Loss / High Efficiency
- New Package Provides Capability of Inspection and Probe After Board Mounting
- Guardring for Stress Protection
- Low Forward Voltage Drop
- 150°C Operating Junction Temperature
- Wettable Flacks Option Available
- NRVB Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These are Pb-Free Devices

Mechanical Characteristics:

- Case: Epoxy, Molded
- Epoxy Meets Flammability Rating UL 94–0 @ 0.125 in.
- Lead Finish: 100% Matte Sn (Tin)
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Device Meets MSL 1 Requirements

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	40	V
Average Rectified Forward Current (Rated V _R , T _C = 140°C)	I _{F(AV)}	12	Α
Peak Repetitive Forward Current, (Rated V_R , Square Wave, 20 kHz, $T_C = 138^{\circ}C$)	I _{FRM}	20	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I _{FSM}	150	A
Storage Temperature Range	T _{stg}	-65 to +175	°C
Operating Junction Temperature	T_J	-55 to +150	°C
Unclamped Inductive Switching Energy (10 mH Inductor, Non-repetitive)	E _{AS}	150	mJ
ESD Rating (Human Body Model)		3B	
ESD Rating (Machine Model)		M4	·

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

NOTE: The heat generated must be less than the thermal conductivity from Junction–to–Ambient: dPD/dTJ < 1/RJA.



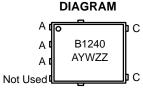
ON Semiconductor®

http://onsemi.com

SCHOTTKY BARRIER RECTIFIERS 12 AMPERES 40 VOLTS







MARKING

B1240 = Specific Device Code A = Assembly Location

Y = Year
W = Work Week
ZZ = Lot Traceability

ORDERING INFORMATION

Device	Package	Shipping†
MBR1240MFST1G	SO-8 FL (Pb-Free)	1500 / Tape & Reel
MBR1240MFST3G	SO-8 FL (Pb-Free)	5000 / Tape & Reel
NRVB1240MFST1G	SO-8 FL (Pb-Free)	1500 / Tape & Reel
NRVB1240MFST3G	SO-8 FL (Pb-Free)	5000 / Tape & Reel

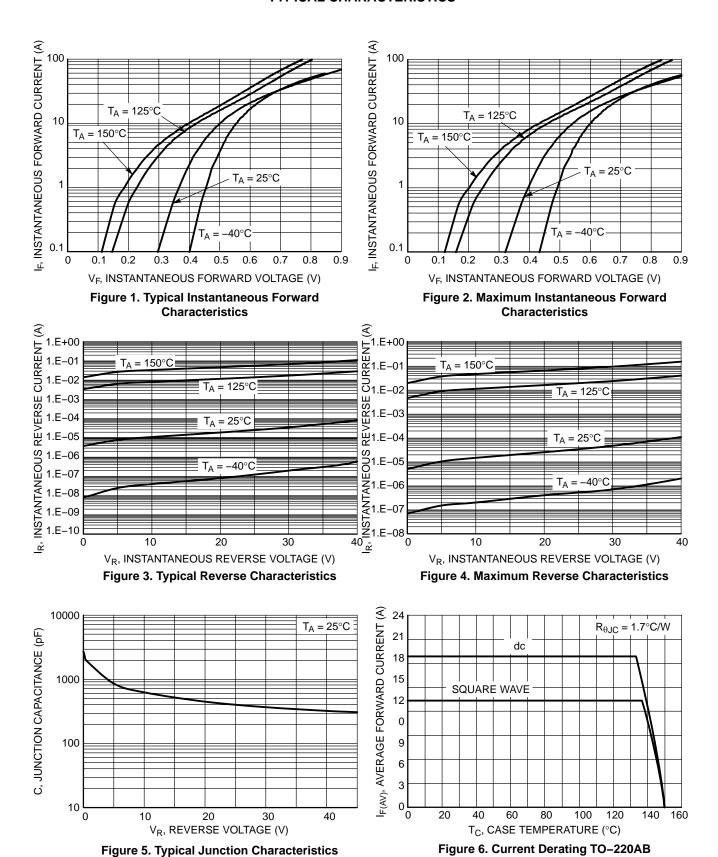
†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Тур	Max	Unit
Thermal Resistance, Junction–to–Case, Steady State (Assumes 600 mm ² 1 oz. copper bond pad, on a FR4 board)	$R_{ heta JC}$	-	1.7	°C/W
ELECTRICAL CHARACTERISTICS	•			
Instantaneous Forward Voltage (Note 1) ($i_F = 12 \text{ A}, T_J = 125^{\circ}\text{C}$) ($i_F = 12 \text{ A}, T_J = 25^{\circ}\text{C}$)	V _F	0.455 0.53	0.62 0.68	V
Instantaneous Reverse Current (Note 1) (Rated dc Voltage, T _J = 125°C) (Rated dc Voltage, T _J = 25°C)	i _R	35 0.08	170 0.5	mA

^{1.} Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2.0%.

TYPICAL CHARACTERISTICS



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TYPICAL CHARACTERISTICS

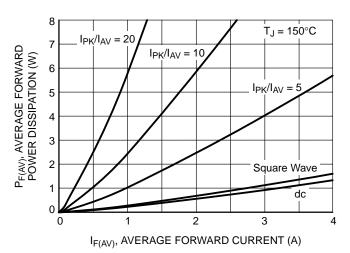


Figure 7. Forward Power Dissipation

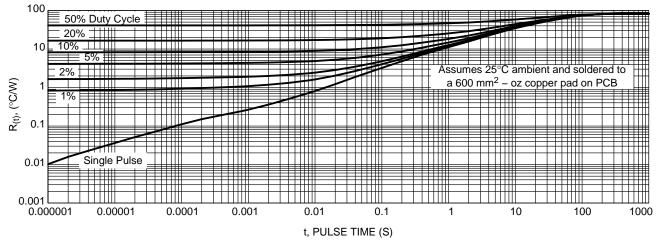
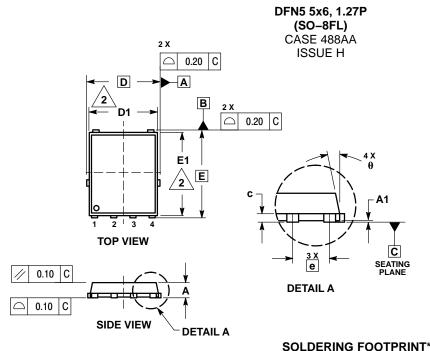


Figure 8. $R_{(t)}$ vs. Duty

PACKAGE DIMENSIONS



NOTES:

- 1. DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETER.
- DIMENSION D1 AND E1 DO NOT INCLUDE MOLD FLASH PROTRUSIONS OR GATE BURRS.

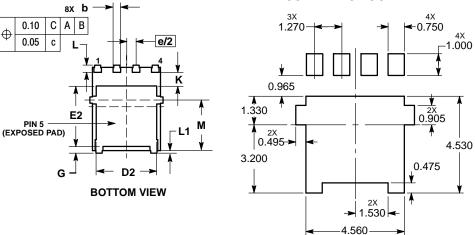
	MILLIMETERS			
DIM	MIN	NOM	MAX	
Α	0.90	1.00	1.10	
A1	0.00		0.05	
b	0.33	0.41	0.51	
С	0.23	0.28	0.33	
D	5.15 BSC			
D1	4.70	4.90	5.10	
D2	3.80	4.00	4.20	
E	6.15 BSC			
E1	5.70	5.90	6.10	
E2	3.45	3.65	3.85	
е	1.27 BSC			
G	0.51	0.61	0.71	
K	1.20	1.35	1.50	
L	0.51	0.61	0.71	
L1	0.05	0.17	0.20	
М	3.00	3.40	3.80	
θ	0 °		12 °	

STYLE 2:

PIN 1. ANODE

- 2. ANODE 3. ANODE
- 4. NO CONNECT 5. CATHODE





*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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